

Dual High-Efficiency PWM Step-Down DC-DC Converter

GENERAL DESCRIPTION

The AX3771 is a dual high-efficiency Pulse-Skipping-Modulated (PSM) step-down DC-DC converter. It is capable of delivering 1A output current over a wide input voltage range from 2.5V to 7.5V, the AX3771 is ideally suited for portable electronic devices that are powered from 1-cell Li-ion battery or from other power sources within the range such as cellular phones, PDAs and other handheld devices.

Two operational modes are available: PSM/Low-Dropout auto-switch and shutdown modes. Internal synchronous rectifier with low R_{DS(ON)} dramatically reduces conduction loss at PSM mode. No external Schottky diode is required in practical application.

The AX3771 enters Low-Dropout mode when normal PSM cannot provide regulated output voltage by continuously turning on the upper PMOS. The AX3771 enter shutdown mode and consumes less than 0.1µA when EN pin is pulled low.

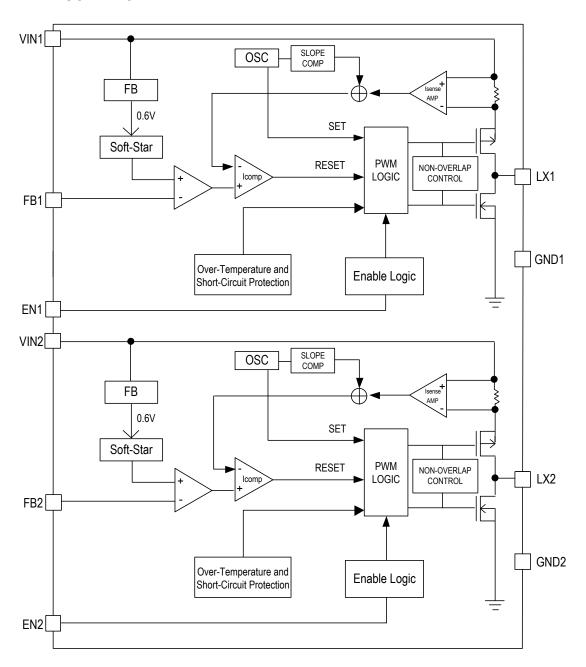
The switching ripple is easily smoothed-out by small package filtering elements due to a fixed operation frequency of 1.4MHz. This along with small TDFN-12L (3x3) package provides small PCB area application. Other features include soft start, lower internal reference voltage with 2% accuracy, over temperature protection, and over current protection.

FEATURES

- 2.5V to 7.5V Input Voltage Range
- Adjustable Output Voltage from 0.6V to VIN
- 1.4MHz Constant Frequency Operation
- 1.2A Output Current/per channel
- High Efficiency: up to 95%
- No Schottky Diode Required
- 100% Duty Cycle in Dropout
- Current Mode Operation for Excellent Line and Load Transient Response
- Current limit, Enable function
- Short Circuit Protect (SCP)
- Small 12-Lead TDFN Package
- RoHS and Halogen free compliance.



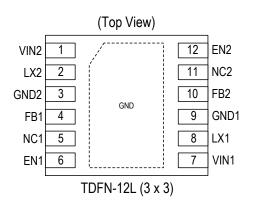
BLOCK DIAGRAM





PIN ASSIGNMENT

The package of AX3771 is TDFN-12L (3×3); the pin assignment is given by:



Name	Description					
VIN2	Power Input of Channel 2.					
LX2	Pin for Switching of Channel 2.					
GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.					
FB1	Feedback of Channel 1.					
NC1, NC2	No Connection Pin.					
EN1	Chip Enable of Channel 1 (Active High). VEN1 \leq VIN1.					
VIN1	Power Input of Channel 1.					
LX1	Pin for Switching of Channel 1.					
FB2	Feedback of Channel 2.					
EN2	Chip Enable of Channel 2 (Active High). VEN2 \leq VIN2.					

ORDER/MARKING INFORMATION

Order Information	Top Marking		
AX3771 XXX X Package Type Packing J12: TDFN-12L (3*3) A: Taping	3 7 7 1 → Part number YYWWX → ID code: internal WW: 01~52 Year: 18=2018 19=2019 20=2020 21=2021 22=2022 45=2045		

❖ ABSOLUTE MAXIMUM RATINGS (at T_A=25°C)

Characteristics	Symbol	Rating	Unit
Supply Input Voltage	V _{IN1} / V _{IN2}	V_{SS} -0.3 to V_{SS} +8	V
2ms Pulse width VIN tolerance	V_{PLUSE}	V_{SS} -0.3 to V_{SS} +10	V
EN1, FB1, LX1, EN2, FB2 and LX2 Pin Voltage		V _{SS} -0.3 to V _{IN} +0.3	V
Power Dissipation, PD @ T _A = 25°C	PD	(T _J -T _A) / θ _{JA}	W
Lead Temperature (Soldering, 10 sec.)		260	°C
Storage Temperature Range	T_{ST}	-40 to 150	°C
Operating Temperature Range	T _{OP}	-40 to +85	°C
Junction Temperature	T_J	125	°C
Thermal Resistance from Junction to case	θ_{JC}	8.2	°C/W
Thermal Resistance from Junction to ambient	θ_{JA}	60	°C/W

Note: θ_{JA} is measured with the PCB copper area of approximately 1 in²(Multi-layer). That need connect to exposed pad.

3/12

ELECTRICAL CHARACTERISTICS

(V_{IN}=3.6V, T_A=25°C, I_{MAX}=1A unless otherwise specified)

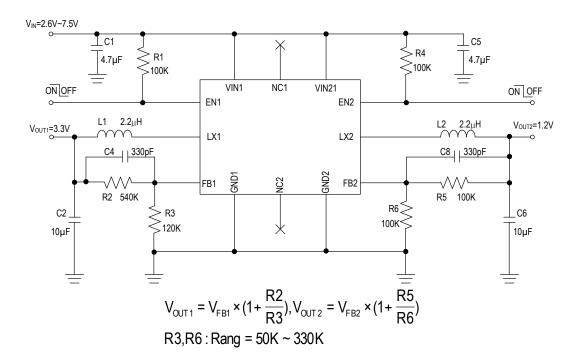
Characteristics	Symbol	Conditions	Min	Тур	Max	Units	
Channel 1 and Channel 2							
Input Voltage Range	V _{IN}		2.5	-	7.5	V	
Under Voltage Lock Out threshold	UVLO		-	1.8	-	V	
Hysteresis			-	0.1	-	V	
Quiescent Current (per channel)	ΙQ	I _{OUT} =0mA, V _{FB} =1V	-	250	350	μΑ	
Shutdown Current	I _{SD}	$V_{EN1} = V_{EN2} = 0V$	-	0.1	1	μA	
Feedback Voltage	V_{FB}		0.588	0.6	0.612	V	
Output Voltage Accuracy	Δ V _{OUT}	V_{IN} =2.5V to 5.5V, 0A < I_{OUT} < 1A	-3	1	+3	%	
FB Input Current	I _{FB}	$V_{FB} = V_{IN}$	-50	-	50	nΑ	
RDS(ON) of P-MOSFET	R _{DS(ON)_P}	V _{FB} =0V, I _{OUT} = 500mA	-	0.26	0.33	Ω	
RDS(ON) of N-MOSFET	R _{DS(ON)_N}	I _{OUT} = 500mA (Note)	-	0.26	0.33	Ω	
P-Channel Current Limit	I _{LIM_P}	I _{OUT} =1.2A	1.7	2.0	2.3	Α	
EN High-Level Input Voltage	V _{EN_H}		1.2	-	-	٧	
EN Low-Level Input Voltage	V _{EN_L}		-	-	0.6	V	
Oscillator Frequency	fosc	LX Pin	1.2	1.4	1.6	MHz	
Maximum Duty Cycle		V _{FB} =0.5V	100	-	-	%	
LX Leakage Current	I _{LX}	V _{IN} =3.6V, V _{LX} =0V or V _{LX} =3.6V	-1	-	1	μA	
Thermal Shutdown Temperature	T _{SD}		-	150	-	°C	
Thermal Shutdown Hysteresis	T _{SH}		-	40	-	°C	

Note: Guarantee by design.



APPLICATION CIRCUIT

Adjustable Voltage Regulator



FUNCTION DESCRIPTIONS

Operation

AX3771 is a dual channel, monolithic switching mode step-down DC-DC converter. It utilizes internal MOSFETs to achieve high efficiency and can generate very low output voltage by using internal reference at 0.6V. It operates at a fixed switching frequency, and uses the slope compensated current mode architecture. This step-down DC-DC converter supplies 1.2A output current by each channel with input voltage range from 2.5V to 7.5V.

Current Mode PSM Control

Slope compensated current mode PSM control provides stable switching and cycle-by-cycle current limit for excellent load and line responses and protection of the internal main switch (P-CH MOSFET) and synchronous rectifier (N-CH MOSFET). During normal operation, the internal P-CH MOSFET is turned on for a certain time to ramp the inductor current at each rising edge of the internal oscillator, and switched off when the peak inductor current is above the error voltage. The current comparator, ICOMP limits the peak inductor current. When the main switch is off, the synchronous rectifier will be turned on immediately and stay on until either the inductor current starts to reverse, beginning of the next clock cycle.



Setting the Output Voltage

Application circuit item shows the basic application circuit with AX3771 adjustable output version. The external resistor sets the output voltage according to the following equation:

$$V_{OUT1} = 0.6V \times (1 + \frac{R2}{R3}), V_{OUT2} = 0.6V \times (1 + \frac{R5}{R6})$$

Table 1 Resistor select for output voltage setting

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V _{OUT}	R3/R6	R2/R5			
1.2V	30K	30K			
1.5V	30K	45K			
1.8V	30K	60K			
2.5V	30K	95K			
3.3V	39K	180K			

We guarantee that the duty cycle range of 20% to 80% is able to work well.

Inductor Selection

For most designs, the AX3771 operates with inductors of 2.2µH to 3.3µH. Low inductance values are physically smaller but require faster switching, which results in some efficiency loss. The inductor value can be derived from the following equation:

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_{L} \times f_{OSC}}$$

Where is inductor ripple current. Large value inductors lower ripple current and small value inductors result in high ripple currents. Choose inductor ripple current approximately 20% of the maximum load current 1000mA, ΔI_L=200mA.

Table 2 Inductor select for output voltage setting (V_{IN} =3.6V)

		<u> </u>		
V_{OUT}	1.2V	1.5V	1.8V	2.5V
Inductor	2.2uH	2.2uH	2.2uH	2.2uH
Part Number WE-TPC	7440430022	7440430022	7440430022	7440430022

Note: Part type MH or M (www.we-online.com)

For optimum voltage-positioning load transients, choose an inductor with DC series resistance in the $50 \text{m}\Omega$ to $150 \text{m}\Omega$ range. For higher efficiency at heavy loads (above 200mA), or minimal load regulation (but some transient overshoot), the resistance should be kept below $100 \text{m}\Omega$. The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation.

Input Capacitor Selection

The input capacitor reduces the surge current drawn from the input and switching noise from the device. The input capacitor impedance at the switching frequency shall be less than input source impedance to prevent high frequency switching current passing to the input. A low ESR input capacitor sized for maximum RMS current must be used. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. A $4.7\mu F$ ceramic capacitor for most applications is sufficient.

Output Capacitor Selection

The output capacitor is required to be 10uF to keep the output voltage ripple small and to ensure regulation loop stability. The output capacitor must have low impedance at the switching frequency. Ceramic capacitors with X5R or X7R dielectrics are recommended due to their low ESR and high ripple current.

Compensation Capacitor Selection

The compensation capacitors for increasing phase margin provide additional stability. It is required 330pF, Please refer to demo board Schematic to design.

Thermal Considerations

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junctions to ambient. The maximum power dissipation can be calculated by following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$$

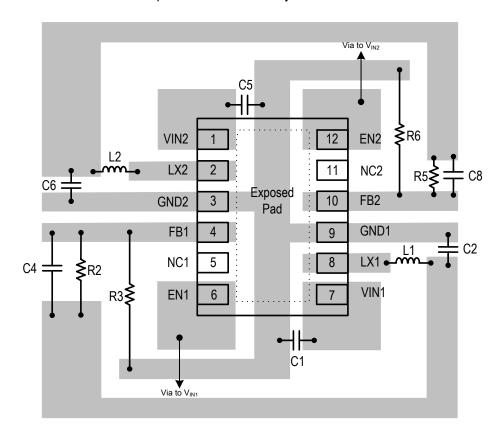
Where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance. For recommended operating conditions specification of AX3771 DC/DC converter, where $T_{J(MAX)}$ is the maximum junction temperature of the die and T_A is the ambient temperature. The junction to ambient thermal resistance θ_{JA} is layout dependent. For TDFN-12L (3x3) packages, the thermal resistance θ_{JA} is 60°C/W on the 1 in² multi-layer PCB copper area (The IC exposed pad must be connected to the PCB copper area) two-layers thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by following formula:

$$P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (60^{\circ}C/W) = 1.667W$$
 for TDFN-12L (3x3) package

The maximum power dissipation depends on operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance θ_{JA} .

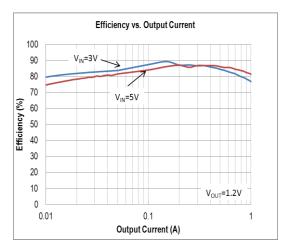
Layout Guide

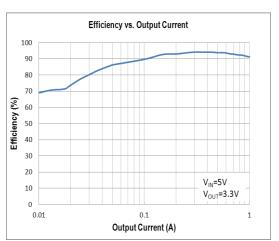
- 1. Input Capacitors (C5, C1) are necessarily closed to IC.
- 2. Feedback low-side resistor's (R3, R6) ground trace close to input capacitor's ground trace.
- 3. All power trace is wide and short.
- 4. Feedback trace must keep inductor's trace away

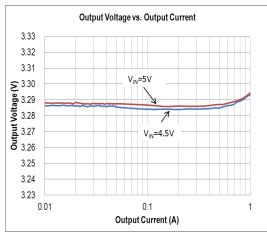


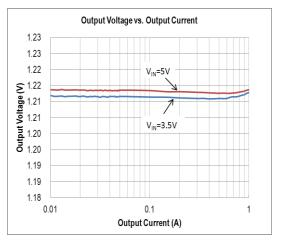


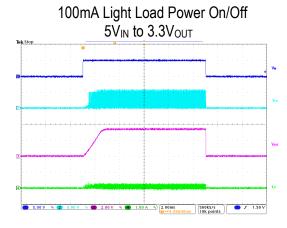
* TYPICAL CHARACTERISTICS

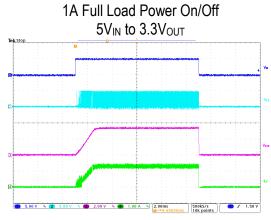






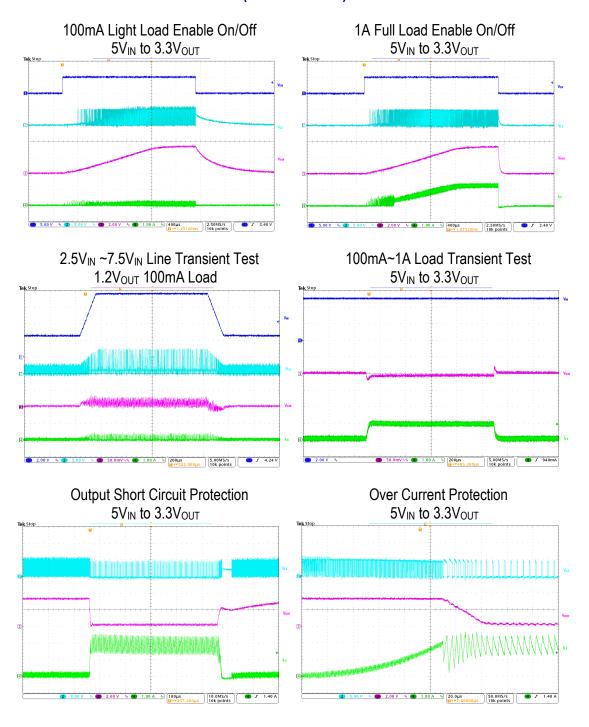






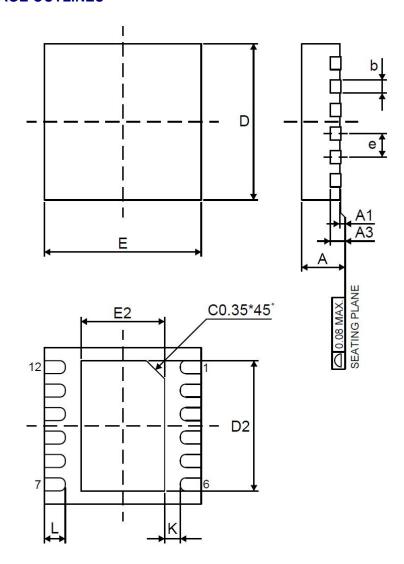


❖ TYPICAL CHARACTERISTICS (CONTINUOUS)





PACKAGE OUTLINES



Symbol	Dimensions in Millimeters			Dimensions in Inches				
	Min.	Nom.	Max.	Min.	Nom.	Max.		
Α	0.70	0.75	0.80	0.028	0.030	0.031		
A1	0.00	0.02	0.05	0.000	0.001	0.002		
A3	A3 0.20 REF 0.00			0.008 REF				
b	0.18	0.25	0.28	0.008	0.010	0.011		
D		3.00 BSC			0.118 BSC			
D2	2.40	2.50	2.55	0.094	0.098	0.100		
E		3.00 BSC			3.00 BSC 0.118 BSC			
E2	1.50	1.60	1.65	0.059	0.063	0.065		
е	0.45 BSC				0.018 BSC			
Ĺ	0.30	0.40	0.50	0.012	0.016	0.002		
K	0.20	-	-	0.008	-	-		



❖ Carrier tape dimension

TDFN-12L(3x3)

